SDZS004A - NOVEMBER 1989 - REVISED MAY 1990

- 100K Compatible
- ECL and TTL Control Inputs
- Noninverting Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Center Pin V<sub>CC</sub>, V<sub>EE</sub>, and GND Configurations Minimize High-Speed Switching Noise
- Package Options Include "Small Outline" Packages and Standard Plastic 300-mil DIPs

# description

This octal ECL-to-TTL translator is designed to provide a efficient translation between a 100K ECL signal environment to a TTL signal environment. This device is designed specifically to improve the performance and density of ECL-to-TTL CPU/bus-oriented functions such as memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

Two output-enable pins,  $\overline{OE}1$  and  $\overline{OE}2$  are provided. These control inputs are ANDed together with  $\overline{OE}1$  being ECL compatible and  $\overline{OE}2$  being TTL compatible. This offers the choice of controlling the outputs of the device from either a TTL or ECL signal environment.

The SN100KT5541 is characterized for operation from 0°C to 85°C.

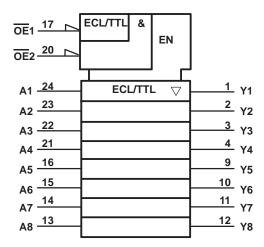
### **FUNCTION TABLE**

OUT	PUT	DATA	OUTPUT
ENA	BLE	INPUT	(TTL)
OE1	OE2	Α	Υ
Х	Н	Х	Z
Н	Х	Х	Z
L	L	L	L
L	L	Н	Н

#### (TOP VIEW) Y1 [ 24 🛮 A1 Y2 **1** 2 23 A2 Y3 **∏** 3 22 A3 Y4 **□** 21 A4 20 OE2 (TTL) V<sub>CC</sub> **∏** 5 19 V<sub>EE</sub> GND 6 18 GND GND [ 7 GND | 8 17 OE1 (ECL) 16 A5 Y5 **∏** 9 Y6 **□** 15 A6 14 A7 **Ү**7 П 11 Y8 **1** 12 13 A8

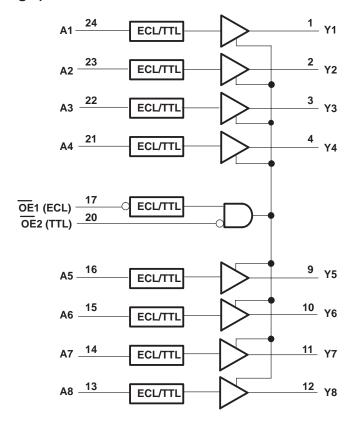
**DW OR NT PACKAGE** 

## logic symbol†



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# logic diagram (positive logic)



# SN100KT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	$\dots$ $$ –0.5 V to 7 V
Supply voltage range, VEE	–8 V to 0 V
Input voltage range (TTL) (see Note 1)	$\dots$ $$ –1.2 V to 7 V
Input voltage range (ECL)	$\dots$ V <sub>EE</sub> to 0 V
Voltage applied to any output in the high state	$\dots$ -0.5 V to V <sub>CC</sub>
Voltage applied to any output in the disabled or power-off state	. $$ –0.5 V to 5.5 V
Input current range (TTL)	-30 mA to 5 mA
Current into any output in the low state	96 mA
Operating free-air temperature range	0°C to 85°C
Storage temperature range	. $-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The TTL input voltage ratings may be exceeded provided the input current ratings are observed.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	TTL supply voltage	4.5	5	5.5	V
VEE	ECL supply voltage	-4.2	-4.5	-4.8	V
VIH	TTL high-level input voltage	2			V
$V_{IL}$	TTL low-level input voltage			0.8	V
$V_{IH}$	ECL high-level input voltage <sup>‡</sup>	-1150		-840	mV
VIL	ECL low-level input voltage‡	-1810		-1490	mV
ΙΙΚ	TTL input clamp current			-18	mA
ІОН	High-level output current			-15	mA
loL	Low-level output current			48	mA
TA	Operating free-air temperature	0		85	°C

<sup>‡</sup> The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic levels only.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	3	MIN	TYP†	MAX	UNIT
VIK	OE2 only	$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -4.2 \text{ V},$	I <sub>I</sub> = –18 mA			-1.2	V
Ц	OE2 only	V <sub>CC</sub> = 5.5 V,	$V_{EE} = -4.8 \text{ V},$	V <sub>I</sub> = 7 V			0.1	mA
lН	OE2 only	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	V <sub>I</sub> = 2.7 V			20	μΑ
I <sub>I</sub> L	OE2 only	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	V <sub>I</sub> = 0.5 V			-0.5	mA
lн	Data inputs and OE1	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	$V_{IH} = -840 \text{ mV}$			350	μΑ
Ι <sub>Ι</sub> Γ	Data inputs and OE1	$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	$V_{IL} = -1810 \text{ mV}$	0.50			μΑ
\/		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -4.5 \text{ V} \pm 0.3 \text{ V},$	IOH = -3  mA	2.4	3.3		V
VOH		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -4.5 \text{ V} \pm 0.3 \text{ V},$	$I_{OH} = -15 \text{ mA}$	2	3.1		V
VOL		$V_{CC} = 4.5 \text{ V},$	$V_{EE} = -4.5 \text{ V} \pm 0.3 \text{ V},$	$I_{OL} = 48 \text{ mA}$		0.38	0.55	V
lozh		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	V <sub>O</sub> = 2.7 V			50	μΑ
lozL		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	$V_0 = 0.5 V$			-50	μΑ
los‡		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V},$	V <sub>O</sub> = 0 V	-100		-225	mA
ICCH		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V}$			64	97	mA
ICCL		$V_{CC} = 5.5 \text{ V},$	$V_{EE} = -4.8 \text{ V}$			80	120	mA
ICCZ		V <sub>CC</sub> = 5.5 V,	V <sub>EE</sub> = -4.8 V			77	116	mA
IEE		V <sub>CC</sub> = 5.5 V,	V <sub>EE</sub> = -4.8 V			-22	-33	mA
Ci		V <sub>CC</sub> = 5 V,	V <sub>EE</sub> = 4.5 V			5		pF
Co		$V_{CC} = 5 V$	V <sub>EE</sub> = 4.5 V			7		pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $V_{EE} = -4.5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	R1 : R2		$_{-}$ = 50 pF, $_{-}$ = 500 $_{-}$ , $_{-}$ = 500 $_{-}$ TYP§ MAX	
tPLH		.,	1.7	4	6.2	$\vdash$
tPHL	А	Y	1.6	4	6.2	ns
<sup>t</sup> PZH	OE1	Υ	2.6	4.7	6.7	ns
<sup>t</sup> PZL	OE1	Ť	3.2	5.9	8.5	
<sup>t</sup> PHZ	OE1	Y	2.9	5.4	7.8	ns
<sup>t</sup> PLZ	OL1	'	1.9	4.9	7.8	113
<sup>t</sup> PZH	ŌE2	Υ	1.7	4	6.2	ns
t <sub>PZL</sub>	) OLZ	'	2.5	5.1	7.7	113
<sup>†</sup> PHZ	<del>OE</del> 2	Υ	2.1	4.3	6.4	nc
tPLZ	OE2	r	1.1	3.7	6.3	ns

<sup>§</sup> All typical values are at  $V_{CC}$  = 5 V,  $V_{EE}$  = -4.5 V,  $T_{A}$  = 25°C.



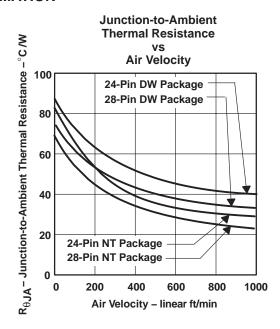
Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

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### THERMAL INFORMATION

In digital system designs utilizing 100KT' or 10KHT' series logic level translators, good thermal management is an important consideration for proper circuit performance and extended reliability. The size of the "small outline" package makes thermal management even more important due to the increased board and thermal densities.

The thermal resistances in Figure 1 can be used to approximate typical and maximum virtual junction temperatures for the SN100KT' and SN10KHT' translators. The junction temperature of these devices may be estimated using Equation 1.



$$T_{J} = R_{\Theta JA} (V_{CC} \bullet I_{CC} + V_{EE} \bullet I_{EE} + P_{DRIVER}) + T_{A}$$
(1)

where

 $T_J$  = virtual junction temperature

 $T_A$  = ambient air temperature

 $R_{\Theta,JA}$  = thermal resistance, junction to ambient air

I<sub>CC</sub> = TTL level supply current (from the databook)

IFF = ECL supply current

V<sub>CC</sub> = TTL level suply voltage (5 V for typical, 5.5 V for maximum)

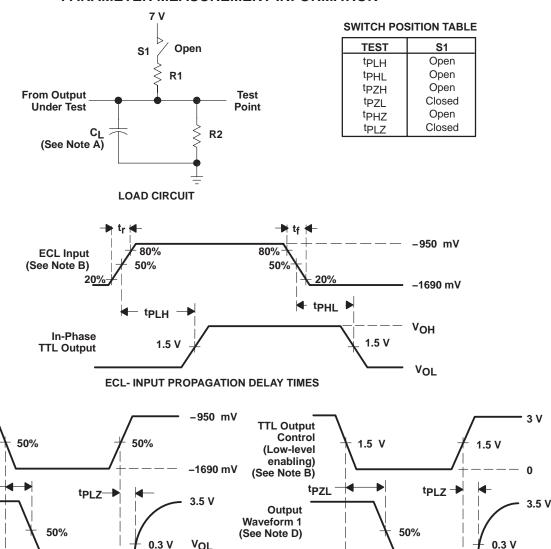
V<sub>FF</sub> = ECL level supply voltage:

SN10KHT' - (-5.2 V Typ, -5.46 V Max)

SN100KHT' - (-54.5 V Typ, -4.80 V Max)

P<sub>DRIVER</sub> = total power consumed by the output driver

### PARAMETER MEASUREMENT INFORMATION



tPZH -

Output

Waveform 2

(See Note D)

VOL

۷он

0.3 V

tPHZ

50%

TTL ENABLE AND DISABLE TIMES

NOTES: A. C<sub>1</sub> includes probe and jig capacitance.

**ECL Output** 

(Low-level

enabling)

Output

Output

Waveform 2

(See Note D)

Waveform 1

(See Note D)

Control

tPZL

<sup>t</sup>PZH

- B. For TTL inputs, input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- C. For ECL inputs, input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq$  1.5 ns.  $t_f \leq$  1.5 ns.
- D. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- E. The outputs are measured one at a time with one transition per measurement.

t<sub>PHZ</sub>▶

50%

**ECL ENABLE AND DISABLE TIMES** 

Figure 1. Load Circuit and Voltage Waveforms



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0

0.3 V





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### **PACKAGING INFORMATION**

Orde	erable Device	Status (1)	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN1	00KT5541DW	OBSOLETE	SOIC	DW	24	TBD	Call TI	Call TI
SN1	00KT5541NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI
SN1	00KT5541NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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